## 502127589 11/13/2012

#### PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

## **CONVEYING PARTY DATA**

Name	Execution Date
Chan-Ching Lin	09/15/2012
Chen-Hao Huang	09/15/2012
Tzung-Bin Huang	09/15/2012
Chun-Cheng Chen	09/15/2012
Ching-Hua Chen	09/15/2012

#### RECEIVING PARTY DATA

Name:	Powerchip Technology Corporation
Street Address:	NO.12, Li-Hsin Road 1, Hsinchu Science Park
City:	Hsinchu
State/Country:	TAIWAN

#### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13674967

#### CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	LKSP0173USA
NAME OF SUBMITTER:	SHELLEY KUO

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> PATENT REEL: 029290 FRAME: 0957

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# **ASSIGNMENT OF INVENTION**

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration.

## ASSIGNOR(S) (Inventors):

Name:	Chan-Ching Lin	Nationality:	TW
Name:	Chen-Hao Huang	Nationality:	TW
mame:	Chen-riao ruang	Nationality:	1 W
Name:	Tzung-Bin Huang	Nationality:	TW
Name:	Chun-Cheng Chen	Nationality:	TW
Name:	Ching-Hua Chen	Nationality:	TW
Hereby sells, as	ssigns and transfers to		
ASSIGNEE(S)	<b>):</b>		
Name:	Powerchip Technology Corporation		
Address:	NO.12, Li-Hsin Road 1, Hsinchu Science	Park, Hsinchu 300.	Taiwan R.O.C.

and the successors and assignees of the ASSIGNEE the entire right, title, and interest in and to any and all improvements which are disclosed in the invention entitled:

# "RESISTIVE RANDOM ACCESS MEMORY AND FABRICATION METHOD THEREOF"

Which is fou	nd in:	
(a)	U.S. patent application executed or	n even date
(b)	U.S. patent application executed or	1
(c)	U.S. application serial no	
(d)	patent no.	issued
(e)	International application no	

and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuations, continuation-in-part, divisions, renewals, substitutes, or extensions thereof, and as to Letters Patent any reissue or re-examination thereof

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the proposes thereof.

IN WITNESS WHEREOF, We have hereunto set hand and seal this signing). (請發明人務必簽署上列日期。)

(Type name of inventor)	Signature of INVENTOR
Chan-Ching Lin	Chan-Ching Lin
Chen-Hao Huang	Chen - Hao Huang
Tzung-Bin Huang	Trang- Bin Huang
Chun-Cheng Chen	Trang-13:n Huang Chan
Ching-Hua Chen	Chuy-ma, Chon

**RECORDED: 11/13/2012**